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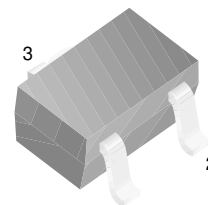
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# FJX4014R

## Switching Application (Bias Resistor Built In)

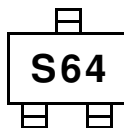
- Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor ( $R_1 = 4.7K\Omega$ ,  $R_2 = 47K\Omega$ )
- Complement to FJX3014R



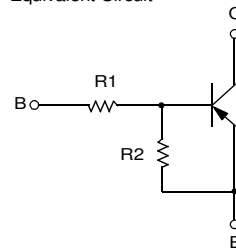
1 SOT-323

1. Base 2. Emitter 3. Collector

Marking



Equivalent Circuit



## PNP Epitaxial Silicon Transistor

### Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol    | Parameter                   | Value     | Units            |
|-----------|-----------------------------|-----------|------------------|
| $V_{CBO}$ | Collector-Base Voltage      | -50       | V                |
| $V_{CEO}$ | Collector-Emitter Voltage   | -50       | V                |
| $V_{EBO}$ | Emitter-Base Voltage        | -10       | V                |
| $I_C$     | Collector Current           | -100      | mA               |
| $P_C$     | Collector Power Dissipation | 200       | mW               |
| $T_J$     | Junction Temperature        | 150       | $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature         | -55 ~ 150 | $^\circ\text{C}$ |

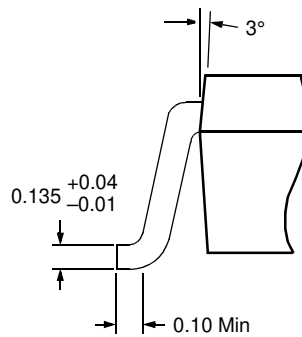
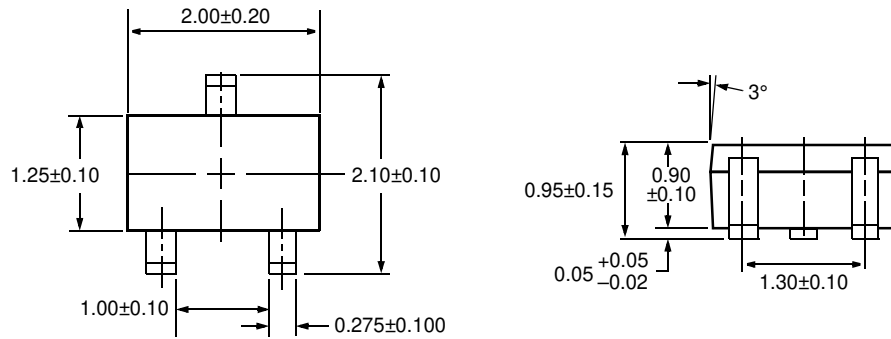
### Electrical Characteristics $T_a = 25^\circ\text{C}$ unless otherwise noted

| Symbol            | Parameter                            | Test Condition  | Min. | Typ. | Max. | Units         |
|-------------------|--------------------------------------|---|------|------|------|---------------|
| $BV_{CBO}$        | Collector-Base Breakdown Voltage     | $I_C = -10\mu\text{A}$ , $I_E = 0$                        | -50  |      |      | V             |
| $BV_{CEO}$        | Collector-Emitter Breakdown Voltage  | $I_C = -100\mu\text{A}$ , $I_B = 0$                       | -50  |      |      | V             |
| $I_{CBO}$         | Collector Cutoff Current             | $V_{CB} = -40\text{V}$ , $I_E = 0$                        |      |      | -0.1 | $\mu\text{A}$ |
| $h_{FE}$          | DC Current Gain                      | $V_{CE} = -5\text{V}$ , $I_C = -5\text{mA}$               | 68   |      |      |               |
| $V_{CE(sat)}$     | Collector-Emitter Saturation Voltage | $I_C = -10\text{mA}$ , $I_B = -0.5\text{mA}$              |      |      | -0.3 | V             |
| $f_T$             | Current Gain Bandwidth Product       | $V_{CE} = -10\text{V}$ , $I_C = -5\text{mA}$              |      | 200  |      | MHz           |
| $C_{ob}$          | Output Capacitance                   | $V_{CB} = -10\text{V}$ , $I_E = 0$<br>$f = 1.0\text{MHz}$ |      | 5.5  |      | pF            |
| $V_I(\text{off})$ | Input Off Voltage                    | $V_{CE} = -5\text{V}$ , $I_C = -100\mu\text{A}$           | -0.5 |      |      | V             |
| $V_I(\text{on})$  | Input On Voltage                     | $V_{CE} = -0.2\text{V}$ , $I_C = -5\text{mA}$             |      |      | -1.3 | V             |
| $R_1$             | Input Resistor                       |   | 3.2  | 4.7  | 6.2  | $K\Omega$     |
| $R_1/R_2$         | Resistor Ratio                       |   | 0.09 | 0.1  | 0.11 |               |

# Package Dimensions

FJX4014R

## SOT-323



Dimensions in Millimeters

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| ActiveArray <sup>TM</sup>                         | FACT Quiet series <sup>TM</sup>  | ISOPLANAR <sup>TM</sup>         | POP <sup>TM</sup>                | Stealth <sup>TM</sup>        |
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